

# 50 V, 150 mA P-channel Trench MOSFET Rev. 1 — 23 May 2011

Product data sheet

#### **Product profile** 1.

### **1.1 General description**

P-channel enhancement mode Field-Effect Transistor (FET) in a small SOT323 (SC-70) Surface-Mounted Device (SMD) plastic package using Trench MOSFET technology.

### **1.2 Features and benefits**

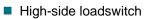
- Logic-level compatible
- Very fast switching
- Trench MOSFET technology

### 1.3 Applications

- Relay driver
- High-speed line driver

### 1.4 Quick reference data

- ESD protection up to 1 kV
- AEC-Q101 qualified



Switching circuits

Table 1.	Quick reference data						
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
$V_{DS}$	drain-source voltage	T <sub>j</sub> = 25 °C		-	-	-50	V
V <sub>GS</sub>	gate-source voltage			-20	-	20	V
I <sub>D</sub>	drain current	$V_{GS}$ = -10 V; $T_{amb}$ = 25 °C	[1]	-	-	-150	mA
Static cha	aracteristics						
R <sub>DSon</sub>	drain-source on-state resistance	$V_{GS}$ = -10 V; I <sub>D</sub> = -100 mA; T <sub>j</sub> = 25 °C		-	4.5	7.5	Ω

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for drain 1 cm<sup>2</sup>.



#### 50 V, 150 mA P-channel Trench MOSFET

## 2. Pinning information

Table 2.	Pinning	information		
Pin	Symbol	Description	Simplified outline	Graphic symbol
1	G	gate		_
2	S	source		
3	D	drain	1 ☐ 2 SOT323 (SC-70)	G Sym146

## 3. Ordering information

Table 3.Ordering information				
Type numb	ber	Package		
		Name	Description	Version
BSS84AKW	/	SC-70	plastic surface-mounted package; 3 leads	SOT323

### 4. Marking

Table 4. Marking codes	
Type number	Marking code <sup>[1]</sup>
BSS84AKW	%VT

[1] % = placeholder for manufacturing site code

### 5. Limiting values

#### Table 5. Limiting values

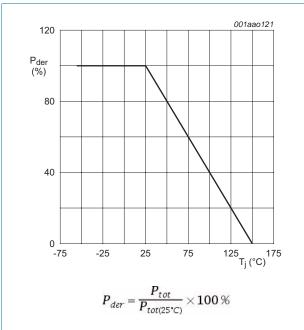
In accordance with the Absolute Maximum Rating System (IEC 60134).

Parameter	Conditions		Min	Max	Unit
drain-source voltage	T <sub>i</sub> = 25 °C		-	-50	V
gate-source voltage	,		-20	20	V
drain current	V <sub>GS</sub> = -10 V; T <sub>amb</sub> = 25 °C	<u>[1]</u>	-	-150	mA
	$V_{GS}$ = -10 V; $T_{amb}$ = 100 °C	<u>[1]</u>	-	-95	mA
peak drain current	$T_{amb} = 25 \text{ °C}$ ; single pulse; $t_p \le 10 \mu\text{s}$		-	-0.6	А
total power dissipation	T <sub>amb</sub> = 25 °C	[2]	-	260	mW
		[1]	-	310	mW
	T <sub>sp</sub> = 25 °C		-	830	mW
junction temperature			-55	150	°C
ambient temperature			-55	150	°C
storage temperature			-65	150	°C
diode					
source current	T <sub>amb</sub> = 25 °C	<u>[1]</u>	-	-150	mA
m rating					
electrostatic discharge voltage	НВМ	[3]	-	1000	V
	drain-source voltage gate-source voltage drain current peak drain current total power dissipation junction temperature ambient temperature storage temperature diode source current m rating	$\begin{array}{c} drain-source \ voltage \\ gate-source \ voltage \\ \\ drain \ current \\ \\ \hline \\ \ \\ \ \\ \ \\ \ \\ \ \\ \ \\ \ \\ \ \\$	$ \begin{array}{c} \mbox{drain-source voltage} & T_{j} = 25 \ ^{\circ}\ C & \\ \mbox{gate-source voltage} & \\ \mbox{drain current} & V_{GS} = -10 \ V; \ T_{amb} = 25 \ ^{\circ}\ C & \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ $	$ \begin{array}{c} \mbox{drain-source voltage} & $T_j = 25 \ {}^{\circ}\ C $ $$ $$ $$ $$ $$ $$ $$ $$ $$ $$ $$ $$$	

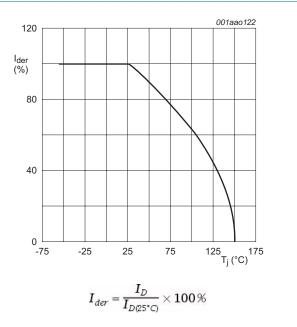
[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for drain 1 cm<sup>2</sup>.

[2] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.

[3] Measured between all pins.



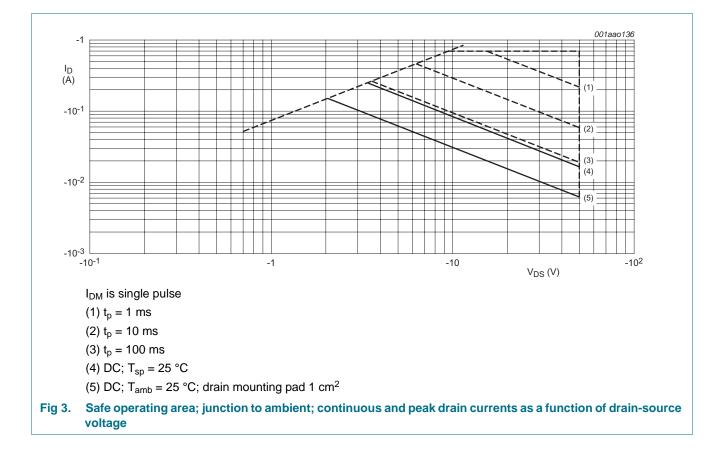






# **BSS84AKW**

#### 50 V, 150 mA P-channel Trench MOSFET

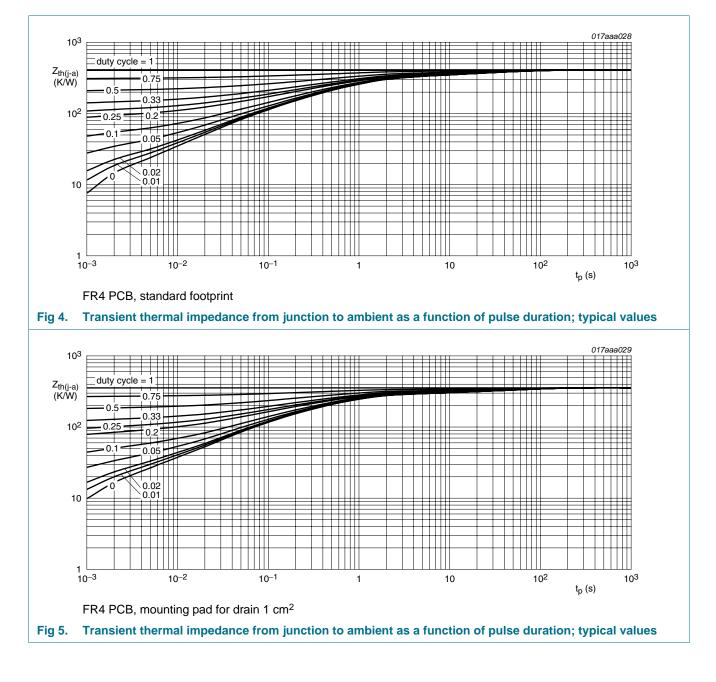


### 6. Thermal characteristics

Table 6.	Thermal characteristics						
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
R <sub>th(j-a)</sub>	thermal resistance from junction to ambient	in free air	<u>[1]</u>	-	415	480	K/W
			[2]	-	350	400	K/W
R <sub>th(j-sp)</sub>	thermal resistance from junction to solder point			-	-	150	K/W

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for drain 1 cm<sup>2</sup>.

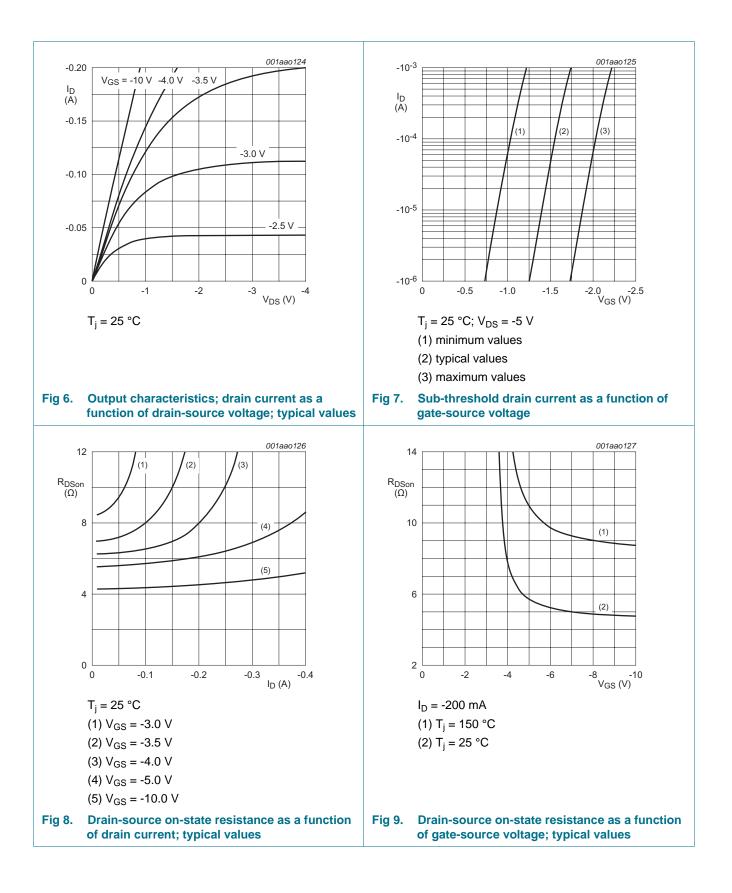


### 7. Characteristics

Table 7.	Characteristics					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static cha	aracteristics					
V <sub>(BR)DSS</sub>	drain-source breakdown voltage	$I_D$ = -10 µA; $V_{GS}$ = 0 V; $T_j$ = 25 °C	-50	-	-	V
V <sub>GSth</sub>	gate-source threshold voltage	$I_D$ = -250 µA; $V_{DS}$ = $V_{GS}$ ; $T_j$ = 25 °C	-1.1	-1.6	-2.1	V
I <sub>DSS</sub>	drain leakage current	$V_{DS} = -50 \text{ V}; V_{GS} = 0 \text{ V}; T_j = 25 \text{ °C}$	-	-	-1	μA
		$V_{DS} = -50 \text{ V}; V_{GS} = 0 \text{ V}; T_j = 150 \text{ °C}$	-	-	-2	μA
I <sub>GSS</sub>	gate leakage current	$V_{GS}$ = -20 V; $V_{DS}$ = 0 V; $T_j$ = 25 °C	-	-	-10	μA
		$V_{GS} = 20 \text{ V};  V_{DS} = 0  \text{V};  \text{T}_{j} = 25 ^{\circ}\text{C}$	-	-	-10	μA
R <sub>DSon</sub>	drain-source on-state resistance	$V_{GS}$ = -10 V; I <sub>D</sub> = -100 mA; T <sub>j</sub> = 25 °C	-	4.5	7.5	Ω
		$V_{GS}$ = -10 V; I <sub>D</sub> = -100 mA; T <sub>j</sub> = 150 °C	-	8	13.5	Ω
		$V_{GS}$ = -5 V; I <sub>D</sub> = -100 mA; T <sub>j</sub> = 25 °C	-	5.7	8.5	Ω
9 <sub>fs</sub>	forward transconductance	$V_{DS}$ = -10 V; I <sub>D</sub> = -100 mA; T <sub>j</sub> = 25 °C	-	150	-	mS
Dynamic	characteristics					
Q <sub>G(tot)</sub>	total gate charge	$V_{DS}$ = -25 V; $I_{D}$ = -200 mA; $V_{GS}$ = -5 V;	-	0.26	0.35	nC
$Q_{GS}$	gate-source charge	T <sub>j</sub> = 25 °C	-	0.12	-	nC
$Q_{GD}$	gate-drain charge		-	0.09	-	nC
C <sub>iss</sub>	input capacitance	$V_{DS} = -25 \text{ V}; \text{ f} = 1 \text{ MHz}; \text{ V}_{GS} = 0 \text{ V};$	-	24	36	pF
C <sub>oss</sub>	output capacitance	T <sub>j</sub> = 25 °C	-	4.5	-	pF
C <sub>rss</sub>	reverse transfer capacitance		-	1.3	-	pF
t <sub>d(on)</sub>	turn-on delay time	$V_{DS}$ = -30 V; $R_{L}$ = 250 $\Omega$ ; $V_{GS}$ = -10 V;	-	13	26	ns
t <sub>r</sub>	rise time	$R_{G(ext)} = 6 \Omega; T_j = 25 °C$	-	11	-	ns
t <sub>d(off)</sub>	turn-off delay time		-	48	96	ns
t <sub>f</sub>	fall time		-	25	-	ns
Source-d	rain diode					
V <sub>SD</sub>	source-drain voltage	I <sub>S</sub> = -115 mA; V <sub>GS</sub> = 0 V; T <sub>i</sub> = 25 °C	-0.48	-0.85	-1.2	V

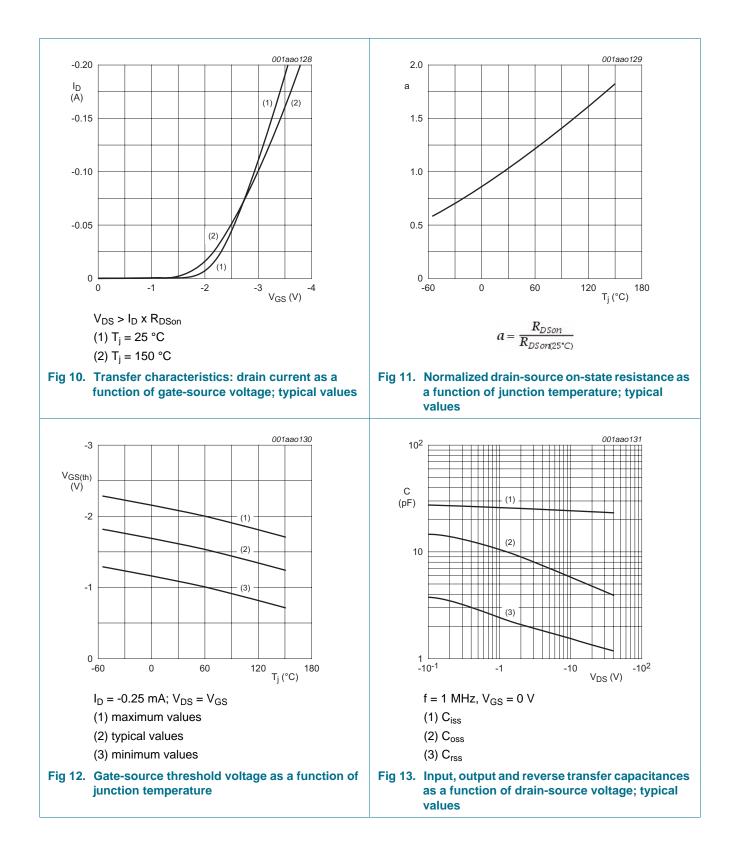
# **BSS84AKW**

#### 50 V, 150 mA P-channel Trench MOSFET



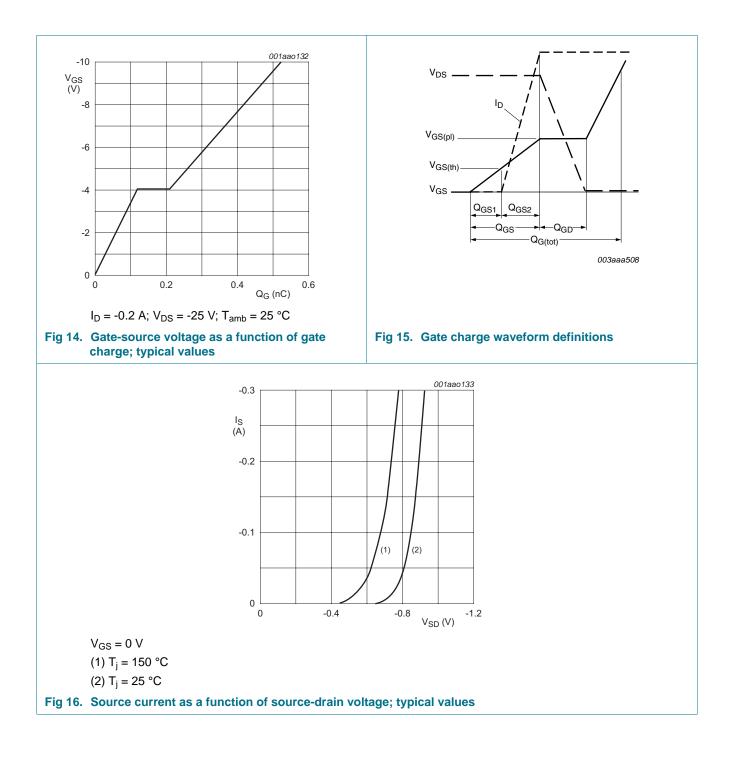
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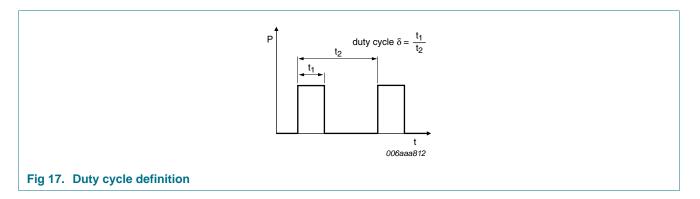
# **BSS84AKW**

#### 50 V, 150 mA P-channel Trench MOSFET



50 V, 150 mA P-channel Trench MOSFET

### 8. Test information



### 8.1 Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard Q101 - Stress test qualification for discrete semiconductors, and is suitable for use in automotive applications.

50 V, 150 mA P-channel Trench MOSFET

### 9. Package outline

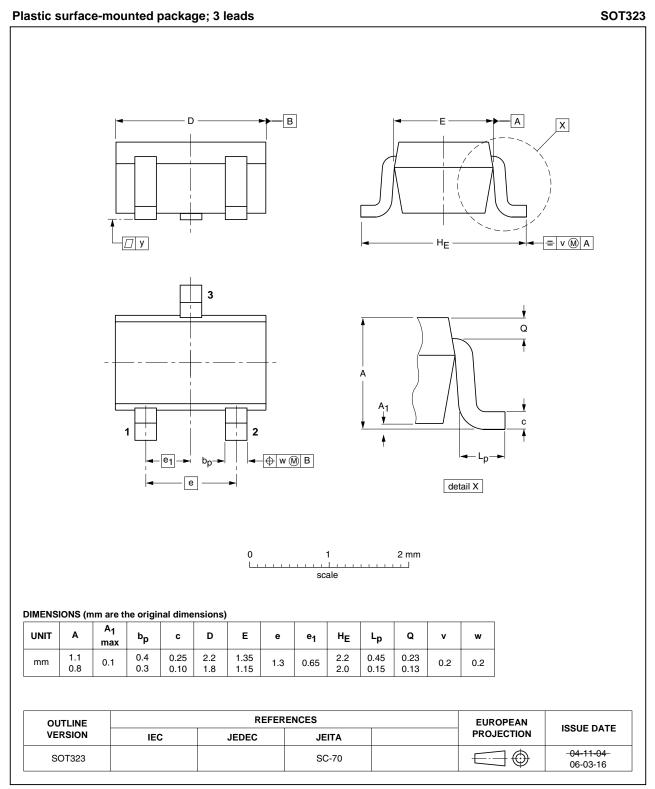
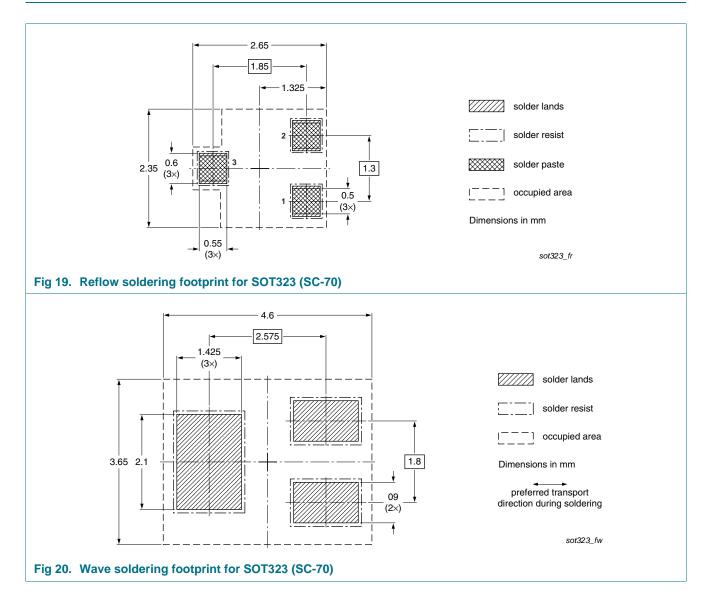


Fig 18. Package outline SOT323 (SC-70)

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50 V, 150 mA P-channel Trench MOSFET

### **10. Soldering**



## **11. Revision history**

Table 8.	Revision history						
Document	ID	Release date	Data sheet status	Change notice	Supersedes		
BSS84AKW	V v.1	20110523	Product data sheet	-	-		

### **12. Legal information**

#### **12.1 Data sheet status**

Document status [1] [2]	Product status 3	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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Product data sheet

#### 50 V, 150 mA P-channel Trench MOSFET

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#### 50 V, 150 mA P-channel Trench MOSFET

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